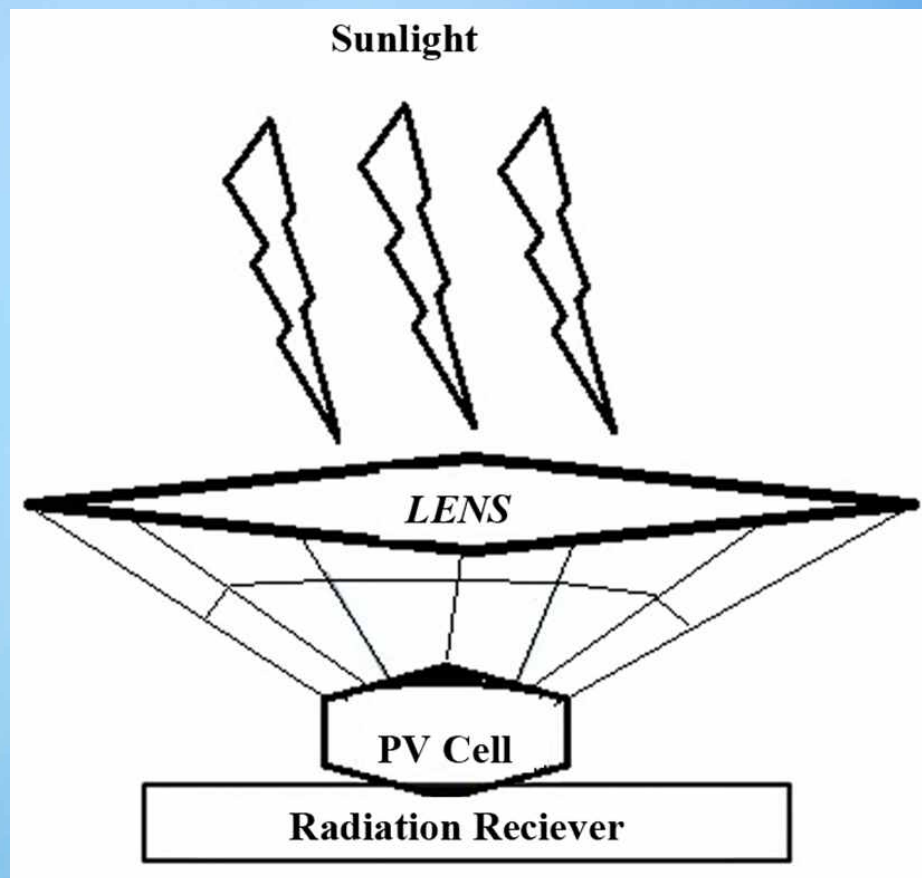


Materials Sciences and Applications



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Table of Contents

Volume 6 Number 12

December 2015

Study and Characterization of Soft Magnetic Properties of $\text{Fe}_{73.5}\text{Cu}_1\text{Nb}_3\text{Si}_{13.5}\text{B}_9$ Magnetic Ribbon Prepared by Rapid Quenching Method	
M. K. Hossain, J. Ferdous, M. M. Haque, M. A. Hakim.....	1089
Development of a High-Performance Flexible Substrate for Flexible Electronics: Joining TAC Films and an Ultra-Thin Glass by Using TEOS-DAC Synthesized by the Sol-Gel Method	
T. Ohishi, H. Kawada, T. Yoshida, T. Ohwada.....	1100
Anatomical Properties of Three Lesser Utilised Ghanaian Hardwood Species	
G. A. Quartey.....	1111
Analysis of Super Duplex Stainless Steel Properties as an Austenite-Ferrite Composite	
F. M. Elsabbagh, A. El-Sabbagh, R. M. Hamouda, M. A. Taha.....	1121
Mechanical and Microstructural Evaluation of Plastically Deformed Brass	
M. A. Bodude, I. Momohjimoh, R. N. Nnaji.....	1137
Solar Cells: In Research and Applications—A Review	
S. Sharma, K. K. Jain, A. Sharma.....	1145

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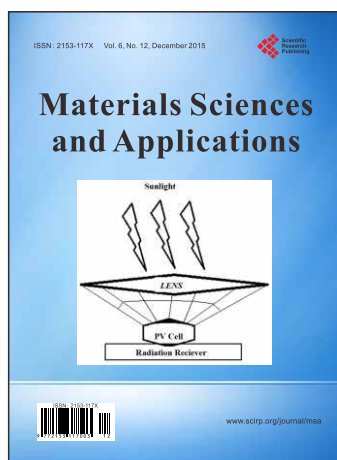
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